### **Planar X Series**

BOARD LEVEL CERAMIC BASED THICK FILM RF FILTER CAPABILITY



Planar X Series is part of an overarching initiative by Smiths Interconnect that entails the creation of best-in-class planar RF filter solutions designed and tested to support various applications markets.

Planar X Series compliments Smiths Interconnect's broad portfolio of RF/Microwave components with bandpass, bandstop, lowpass and highpass configurations up to 18 GHz (Ku-Band) offering premium performance in a small package. The frequency of operation can be further extended with added material and process capabilities.

Planar X Series leverages Smiths Interconnect's existing thick film process technology on various dielectric substrates which are designed for use in harsh high-reliability environments. The small footprint, light weight and surface mountable configuration allow for high volume pick and place applications and are ideal for SATCOM, Radar and Broadcasting industries. In addition, Smiths Interconnect offers value added high-reliability test options providing assurance in mission critical defense and space applications.

Regardless of the application, our internal processes and procedures help ensure that all filters are fully compliant to customers' specifications. Best-in-class RF Filter solutions up to 18 GHz designed and tested to support various applications and markets.

#### Features and Benefits

- Small Footprint Reduced PCB Footprint
- Light Weight Reducing overall system mass in critical space applications
- Excellent Rejection Characteristics Providing best in class RF performance
- Surface Mountable Ideal solutions for Pick and Place Applications
- Robust Materials Suitable for Harsh Environment
- Frequency Offerings up to 18 GHz Suitable for a wide array of applications

#### **Applications**

- Transmit/Receive Modules
- Up/Down Converters
- Instrumentation
- Satellite Communications
- Radar
- Broadcast

### **Technical Capability Characteristics**

#### Filter Design Capabilities

Electrical				
Characteristic Impedance	50 ohms			
Operating Frequency	Up to 18 GHz			
Rejection Criteria	Up to 30 dB over 5% Bandwidth			
Input Power CW	Up to 10 Watts			
Environmental				
Operating Temperature	-40°C to +85°C			
Storage Temperature	-65°C to +150°C			
Moisture Sensitivity Level	1 - Unlimited			
Mechanical				
Configuration	Surface Mount or Wire Bondable Chip Packages			
Package Size	Varies based on Electrical Requirements and Dielectric			
Substrate Materials	Various Dielectrics Options Available			
Conductor Material	Thick Film with Tin/Lead or RoHS Compliant Silver Plating			
Shielding Material	Stainless Steel (If required)			
Quality Assurance				
	Sample visual and mechanical inspection - 1.0 AQL per mechanical drawing requirements			
	Periodic electrical inspection performed for commerical grade products			
	High reliability tested products are available			
Marking				
Unit Marking	Available if required			
Packaging				
Standard Packaging	Waffle Pack or Tape and Reel			



### **Additional Test Capabilities**

Smiths Interconnect can provide a wide array of add-on test services to suit market and program needs. Below is a list of standard available test options. Please consult factory for individual program needs.

Per MIL-PRF-55342				
Outgassing (space level only)	Thermal Shock			
Visual and Mechanical	Power Conditioning (space level only)			
Precap Visual Inspection	Low Temperature Operation			
Solderability	Short Time Overload			
Solder Mounting Integrity	High Temperature Exposure			
Bondable Mounting Integrity	Moisture Resistance			
Wire Bonding Integrity	Life Testing			
Resistance to Solvents	Resistance to Soldering Heat			
Marking Legibility Test	Resistance to Bonding Exposure			
Per MIL-STD-883				
Barometric Pressure, Reduced (Altitude Operation)	Moisture Resistance			
Insulation Resistance	Salt At			

## How To Order

#### Specify Model Number: XPFX-XXXX/XXX-M

X P F X	XXXX	XXX	Μ		
1	2	3	4		
1 Series Name	X P F X X - Number of Sections	PF - Printed Filter	X - Special Design if required		
2 Frequency	X X X X X XXXX - Center Frequency in MHz				
3 Bandwidth	X X X X Bandwidth in MHz				
4 Options	M Surface Mount				

# Global Support

#### Americas

- Costa Mesa, CA
  +1 714 371 1100
  info.us@smithsinterconnect.com
- Milpitas, CA
  +1 408 957 9607 x-1125
  info.us@smithsinterconnect.com
- Stuart, FL
  +1 772 286 9300
  info.us@smithsinterconnect.com
- Kirkland, QC, Canada
  +1 514 842 5179
  info.us@smithsinterconnect.com

### Еигоре

- Deggendorf, Germany
  +49 991 250 120
  info.de@smithsinterconnect.com
- Genova, Italy
  +39 0 10 60361
  info.it@smithsinterconnect.com

### Asia

- Bangalore, India
  +91 080 4241 0529
  info.in@smithsinterconnect.com
- Singapore
  +65 6846 1655
  info.asia@smithsinterconnect.com

- Hudson, MA
  +1 978 568 0451
  info.us@smithsinterconnect.com
- Northampton, MA
  +1 413 582 9620
  info.northampton@smithsinterconnectinc.com
- Tampa, FL
  + 1 813 901 7200
  info.tampa@smithsinterconnectinc.com
- Kansas City, KS
  +1 913 342 5544
  info.us@smithsinterconnect.com
- Salisbury, MD
  +1 800 780 2169
  info.us@smithsinterconnect.com
- Thousand Oaks, CA
  +1 805 267 0100
  info.thousandoaks@smithsinterconnectinc.com

- Dundee, UK
  +44 1382 427 200
  info.dundee@smithsinterconnect.com
- Rouen, France
  +33 2 32 96 91 76
  info.fr@smithsinterconnect.com
- Mianyang, China
  +86 816 231 5566
  HSICSR@hf-smiths.com
- Suzhou, China
  +86 512 6273 1188
  info.asia@smithsinterconnect.com

Elstree, UK
 +44 20 8236 2400
 info.uk@smithsinterconnect.com

Shanghai, China
 +86 21 2283 8008
 info.asia@smithsinterconnect.com

more > smithsinterconnect.com

Copyright© 2020 Smiths Interconnect | All rights reserved | Version 1.0 The information contained within this document is subject at all times to applicable Export Control regulations and legal requirements

in 🎽